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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	270
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50e-6fn484i

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

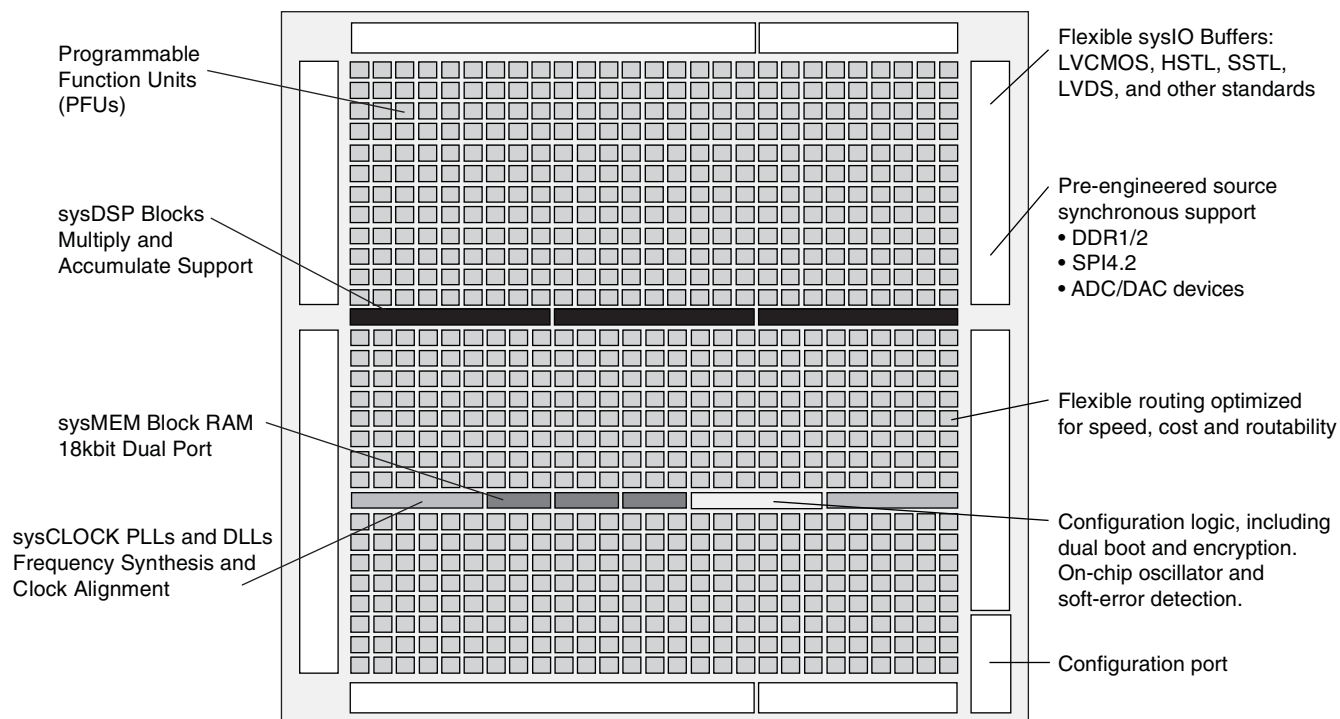
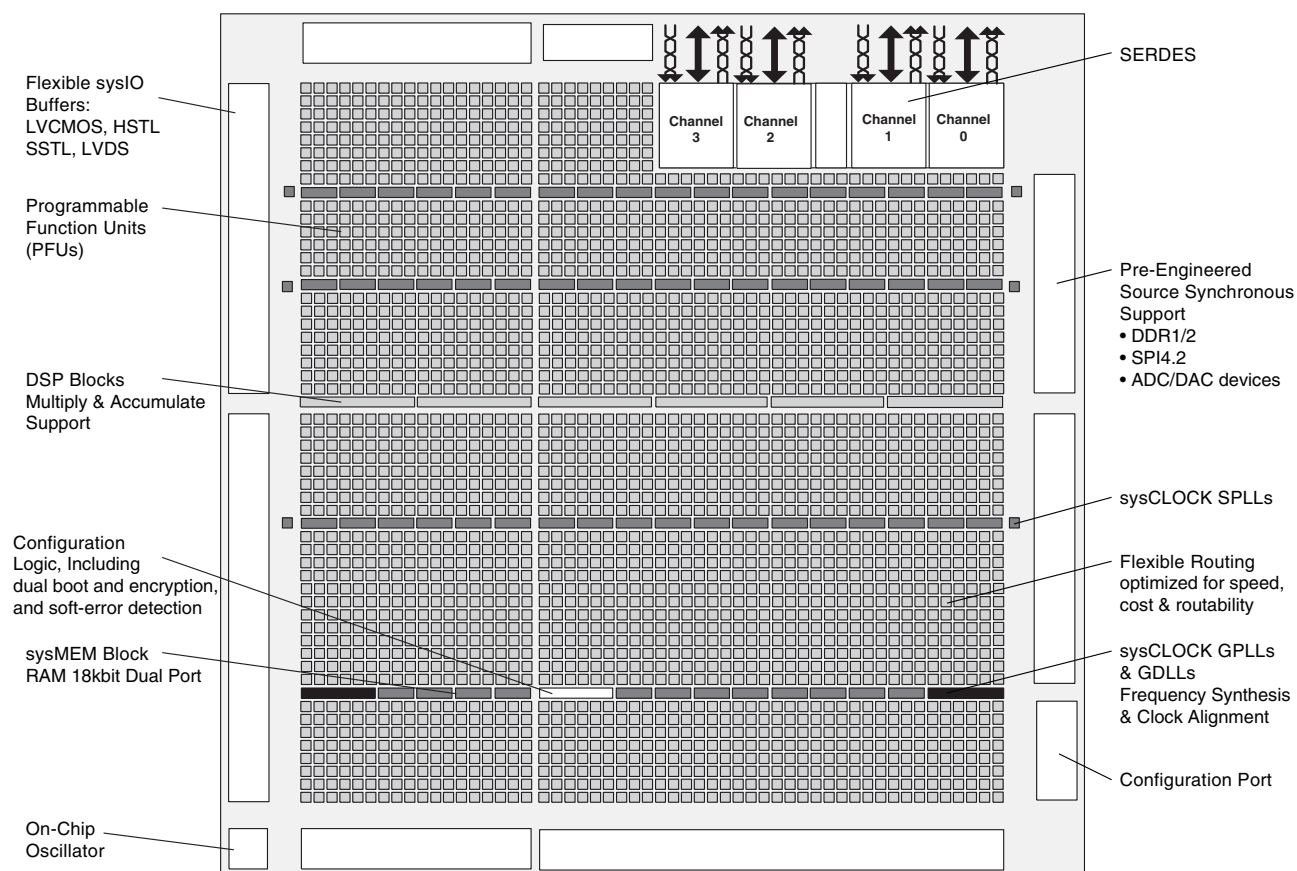


Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)



If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active.

These instructions apply to all EBR RAM and ROM implementations.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

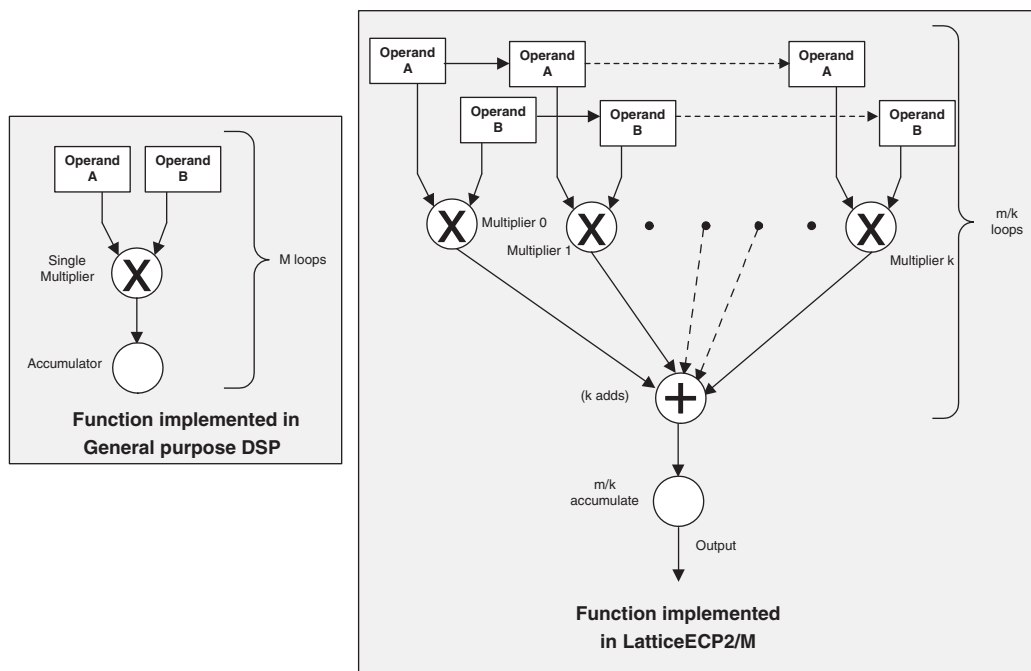
sysDSP™ Block

The LatticeECP2/M family provides a sysDSP block, making it ideally suited for low cost, high performance Digital Signal Processing (DSP) applications. Typical functions used in these applications are Finite Impulse Response (FIR) filters, Fast Fourier Transforms (FFT) functions, Correlators, Reed-Solomon/Turbo/Convolution encoders and decoders. These complex signal processing functions use similar building blocks such as multiply-adders and multiply-accumulators.

sysDSP Block Approach Compared to General DSP

Conventional general-purpose DSP chips typically contain one to four (Multiply and Accumulate) MAC units with fixed data-width multipliers; this leads to limited parallelism and limited throughput. Their throughput is increased by higher clock speeds. The LatticeECP2/M, on the other hand, has many DSP blocks that support different data-widths. This allows the designer to use highly parallel implementations of DSP functions. The designer can optimize the DSP performance vs. area by choosing an appropriate level of parallelism. Figure 2-22 compares the fully serial and the mixed parallel and serial implementations.

Figure 2-22. Comparison of General DSP and LatticeECP2/M Approaches



sysDSP Block Capabilities

The sysDSP block in the LatticeECP2/M family supports four functional elements in three 9, 18 and 36 data path widths. The user selects a function element for a DSP block and then selects the width and type (signed/unsigned) of its operands. The operands in the LatticeECP2/M family sysDSP Blocks can be either signed or unsigned but not mixed within a function element. Similarly, the operand widths cannot be mixed within a block. In the LatticeECP2/M family the DSP elements can be concatenated.

The resources in each sysDSP block can be configured to support the following elements:

- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

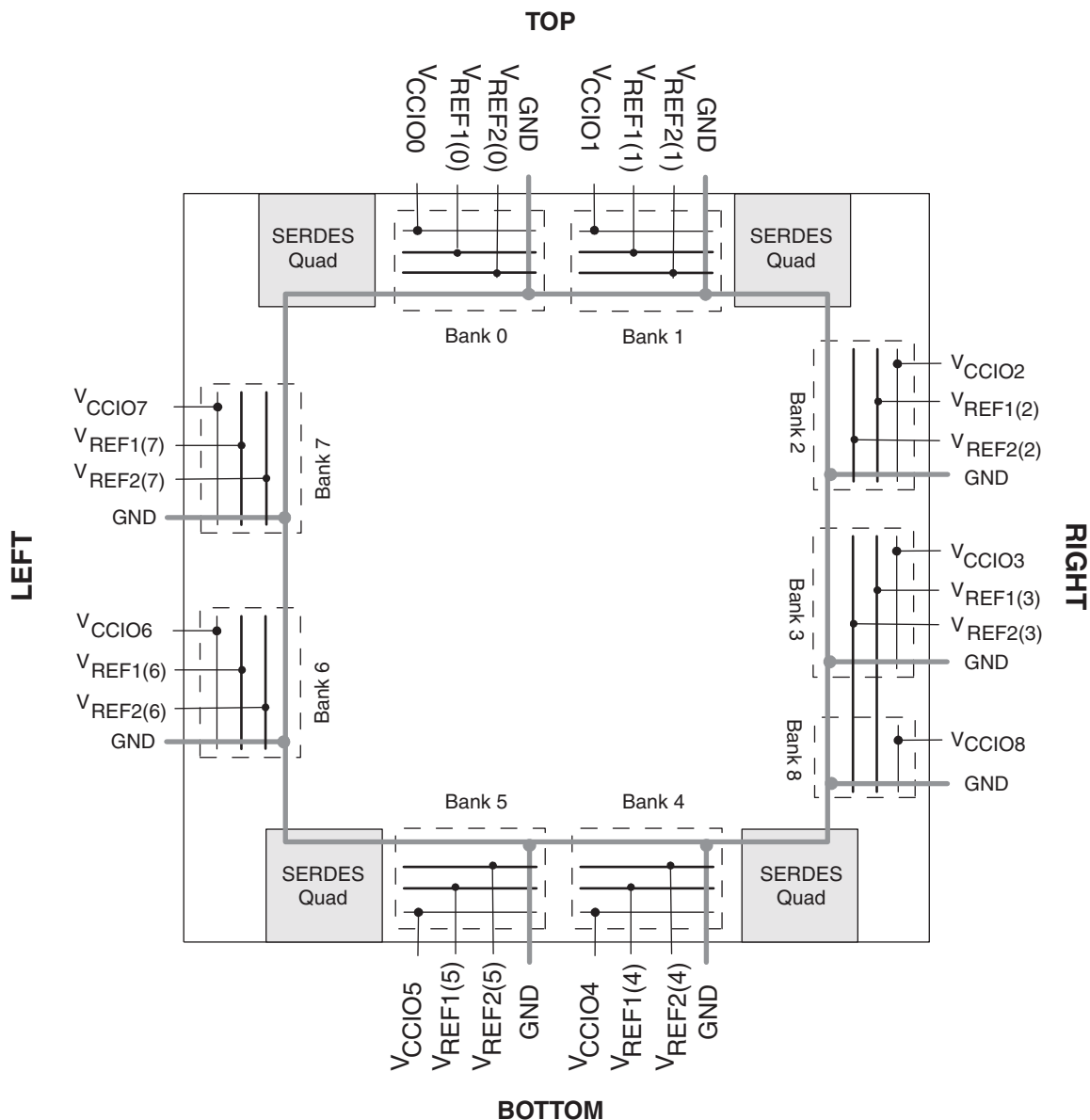
Table 2-7. Maximum Number of Elements in a Block

Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADDSUB	4	2	—
MULTADDSUBSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

Figure 2-38. LatticeECP2M Banks



LatticeECP2/M devices contain two types of sysI/O buffer pairs.

1. **Top (Bank 0 and Bank 1) sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the top banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

2. **Bottom (Bank 4 and Bank 5) sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the bottom banks of the device consist of two single-ended output drivers and two

LatticeECP2/M Internal Switching Characteristics¹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{HWREN_EBR}	Hold Write/Read Enable to PFU Memory	0.139	—	0.156	—	0.173	—	ns
t _{SUCE_EBR}	Clock Enable Setup Time to EBR Output Register	0.123	—	0.134	—	0.145	—	ns
t _{HCE_EBR}	Clock Enable Hold Time to EBR Output Register	-0.081	—	-0.090	—	-0.100	—	ns
t _{RSTO_EBR}	Reset To Output Delay Time from EBR Output Register	—	1.03	—	1.15	—	1.26	ns
t _{SUBE_EBR}	Byte Enable Set-Up Time to EBR Output Register	-0.115	—	-0.130	—	-0.145	—	ns
t _{HBE_EBR}	Byte Enable Hold Time to EBR Output Register	0.138	—	0.155	—	0.172	—	ns
GPLL Parameters								
t _{RSTREC_GPLL}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
SPLL Parameters								
t _{RSTREC_SPLL}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
DSP Block Timing^{2,3}								
t _{SUI_DSP}	Input Register Setup Time	0.12	—	0.13	—	0.14	—	ns
t _{HI_DSP}	Input Register Hold Time	0.02	—	-0.01	—	-0.03	—	ns
t _{SUP_DSP}	Pipeline Register Setup Time	2.18	—	2.42	—	2.66	—	ns
t _{HP_DSP}	Pipeline Register Hold Time	-0.68	—	-0.77	—	-0.86	—	ns
t _{SUO_DSP}	Output Register Setup Time	4.26	—	4.71	—	5.16	—	ns
t _{HO_DSP}	Output Register Hold Time	-1.25	—	-1.40	—	-1.54	—	ns
t _{COI_DSP}	Input Register Clock to Output Time	—	3.92	—	4.30	—	4.68	ns
t _{COP_DSP}	Pipeline Register Clock to Output Time	—	1.87	—	1.98	—	2.08	ns
t _{COO_DSP}	Output Register Clock to Output Time	—	0.50	—	0.52	—	0.55	ns
t _{SUADDSUB}	AddSub Input Register Setup Time	-0.24	—	-0.26	—	-0.28	—	ns
t _{HADDSUB}	AddSub Input Register Hold Time	0.27	—	0.29	—	0.32	—	ns

1. Internal parameters are characterized but not tested on every device.

2. These parameters apply to LatticeECP devices only.

3. DSP Block is configured in Multiply Add/Sub 18x18 Mode.

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)^{1, 2}

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
V _{TX-DIFF-P-P-1}	Differential swing (1V setting) ^{1, 2}	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
V _{TX-DIFF-P-P-1.25}	Differential swing (1.25V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
V _{TX-DIFF-P-P-1.3}	Differential swing (1.3V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
V _{TX-DIFF-P-P-1.35}	Differential swing (1.35V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V _{OCM}	Output common mode voltage	—	V _{CCOB} - 0.75	V _{CCOB} - 0.60	V _{CCOB} - 0.45	V
T _{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T _{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
Z _{TX-OI-SE}	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R _{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.

2. See TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#) for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See “Typical sysI/O I/O Behavior During Power-up” for more information about I/O behavior during power-up.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers.
V _{CCIOx}	—	Dedicated power supply pins for I/O bank x.
V _{CCPLL}	—	PLL supply pins. Should be tied to V _{CC} even when the corresponding PLL is unused.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES ⁴	—	10K ohm +/-1% resistor must be connected between this pad and ground.
PLLCAP ⁴	—	External capacitor connection for PLL.
PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_V _{CCPLL}	—	Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center.
[LOC][num]_GPLL[T, C]_IN_A	I	General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_GPLL[T, C]_FB_A	I	Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_IN_A ⁵	I	Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_FB_A ⁵	I	Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_IN_A	I	DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_FB_A	I	Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.

LatticeECP2 Power Supply and NC

Signals	144 TQFP ³	208 PQFP ³	256 fpBGA ⁴	484 fpBGA ⁴
VCC	16, 22, 29, 48, 54, 83, 94, 102, 128, 135	12, 19, 28, 40, 74, 80, 97, 116, 129, 140, 146, 171, 188, 198	LFE2-6: G7, G9, G10, H7, J10, K10, K8 LFE2-12/LFE2-20: G7, G9, G10, H7, J10, K10, K8	LFE2-12/LFE2-20: N6, N18, J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 LFE2-35/LFE2-50: J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13
VCCIO0	139	195, 206	C5, E7	G10, G9, H8, H9
VCCIO1	117	162, 170	C12, E10	G11, G12, G13, G14
VCCIO2	106	143, 148	E14, G12	H14, H15, J15, K16
VCCIO3	89	123, 135	K12, M14	L16, M16, N16, P16
VCCIO4	64	93, 100	M10, P12	R14, T12, T13, T14
VCCIO5	42	55, 63	M7, P5	R9, T10, T11, T9
VCCIO6	31	38, 44	K5, M3	N7, P7, P8, R8
VCCIO7	9	10, 14	E3, G5	J8, K7, L7, M7
VCCIO8	85	113, 118	T15	P15, R15
VCCJ	35	51	K7	T8
VCCAUX	6, 39, 90, 142	7, 30, 70, 86, 125, 151, 174, 190	G8, H10, J7, K9	G5, K5, R5, V7, V11, V8, V13, V15, M17, P17, E17, G18, D11, F13, C5, E6
VCCPLL	None	None	None	LFE2-12/LFE2-20: None LFE2-35: N6, N18 LFE2-50: N6, N18, K6, J16
GND ¹	11, 21, 30, 47, 51, 61, 81, 95, 105, 120, 133, 138	5, 13, 17, 25, 32, 42, 60, 68, 77, 81, 89, 102, 115, 122, 139, 145, 159, 169, 175, 184, 192, 201	A1, A16, B12, B5, C8, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16	A22, AA19, AA4, AB1, AB22, B19, B4, C14, C9, D2, D21, F17, F6, H10, H11, H12, H13, J14, J20, J3, J9, K10, K11, K12, K13, K15, K8, L10, L11, L12, L13, L15, L8, M10, M11, M12, M13, M15, M8, N10, N11, N12, N13, N15, N8, P14, P20, P3, P9, R10, R11, R12, R13, U17, U6, W2, W21, Y14, Y9, A1
NC ²	LFE2-6: 45, 46, 124, 127 LFE2-12: 127	None	LFE2-6: K6, R3, P4 LFE2-12/LFE2-20: None	LFE2-12: E3, F3, F1, H4, F2, H5, G1, G3, G2, G4, K6, N1, M2, N2, M1, N3, N5, N4, P5, N19, M19, J22, L22, H22, K22, J16, D22, F21, E21, E22, H19, G20, G19, F20, C21, C22, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-20/LFE2-35: K6, J16, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-50: None

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. Pin orientation follows the conventional order from the pin 1 marking of the top side view and counter-clockwise.
4. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
V _{CC}	LFE2M35: AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2M50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	LFE2M50: AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19 LFE2M70/LFE2M100: L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19
V _{CCIO0}	B12, B7, F11, J13, K12	D14, E6, E9, F12, K12, K13
V _{CCIO1}	D18, F16, J14, K15	D17, E22, E25, F19, K18, K19
V _{CCIO2}	G25, L21, M17, M25, N18	F28, J25, K28, M21, M24, N21, N28, P21, R25
V _{CCIO3}	P18, R17, R25, T21, Y25	AA28, AB25, AE28, T25, U21, V21, V28, W21, W24
V _{CCIO4}	AA16, AC18, U15, V14	AA18, AA19, AE19, AF22, AG17, AG25
V _{CCIO5}	AA11, AE12, AE7, U12, V13	AA12, AA13, AE12, AF9, AG14, AG6
V _{CCIO6}	P9, R10, R2, T6, Y2	AA3, AB6, AE3, T6, U10, V10, V3, W10, W7
V _{CCIO7}	G2, L6, M10, M2, N9	F3, J6, K3, M10, M7, N10, N3, P10, R6
V _{CCIO8}	AC24, U17	AA25, AD28
V _{CCJ}	AA7	AG1
V _{CCAUX}	LFE2M35: AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16 LFE2M50: J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16	LFE2M50: AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21 LFE2M70/LFE2M100: AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21
V _{CCPLL}	H7, K6, P7, R8, V18, P20, J17, G19	N13, N18, V13, V18
SERDES Power ³	LFE2M35: C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13 LFE2M50: AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13	LFE2M50: AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18 LFE2M70/LFE2M100: C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
W5	PL38B	6	LDQ42	C (LVDS)*	PL52B	6	LDQ56	C (LVDS)*	
AC1	PL39A	6	LDQ42	T	PL53A	6	LDQ56	T	
AD1	PL39B	6	LDQ42	C	PL53B	6	LDQ56	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y6	PL40A	6	LDQ42	T (LVDS)*	PL54A	6	LDQ56	T (LVDS)*	
Y5	PL40B	6	LDQ42	C (LVDS)*	PL54B	6	LDQ56	C (LVDS)*	
AE2	PL41A	6	LDQ42	T	PL55A	6	LDQ56	T	
AD2	PL41B	6	LDQ42	C	PL55B	6	LDQ56	C	
GND	GNDIO6	-			GNDIO6	-			
AB3	PL42A	6	LDQS42	T (LVDS)*	PL56A	6	LDQS56	T (LVDS)*	
AB2	PL42B	6	LDQ42	C (LVDS)*	PL56B	6	LDQ56	C (LVDS)*	
W7	PL43A	6	LDQ42	T	PL57A	6	LDQ56	T	
VCCIO	VCCIO6	6			VCCIO6	6			
W8	PL43B	6	LDQ42	C	PL57B	6	LDQ56	C	
Y7	PL44A	6	LDQ42	T (LVDS)*	PL58A	6	LDQ56	T (LVDS)*	
Y8	PL44B	6	LDQ42	C (LVDS)*	PL58B	6	LDQ56	C (LVDS)*	
AC2	PL45A	6	LDQ42	T	PL59A	6	LDQ56	T	
GND	GNDIO6	-			GNDIO6	-			
AD3	PL45B	6	LDQ42	C	PL59B	6	LDQ56	C	
AC3	TCK	-			TCK	-			
AA8	TDI	-			TDI	-			
AB4	TMS	-			TMS	-			
AA5	TDO	-			TDO	-			
AB5	VCCJ	-			VCCJ	-			
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
GND	GNDIO5	-			GNDIO5	-			
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AH12	PB45A	5	BDQ42	T
AF14	PB45B	5	BDQ42	C
AJ13	PB46A	5	BDQ42	T
GND	GNDIO5	-		
AK13	PB46B	5	BDQ42	C
AB15	PB47A	5	BDQ51	T
AD15	PB47B	5	BDQ51	C
AE15	PB48A	5	BDQ51	T
AF15	PB48B	5	BDQ51	C
AG15	PB49A	5	BDQ51	T
AG14	PB49B	5	BDQ51	C
VCCIO	VCCIO5	5		
AH15	PB50A	5	BDQ51	T
AH14	PB50B	5	BDQ51	C
GND	GNDIO5	-		
AJ14	PB51A	5	BDQS51	T
AK14	PB51B	5	BDQ51	C
AD16	PB52A	5	BDQ51	T
AF16	PB52B	5	BDQ51	C
AJ15	PB53A	5	PCLKT5_0/BDQ51	T
AK15	PB53B	5	PCLKC5_0/BDQ51	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AE16	PB58A	4	PCLKT4_0/BDQ60	T
VCCIO	VCCIO4	4		
AC15	PB58B	4	PCLKC4_0/BDQ60	C
AJ16	PB59A	4	BDQ60	T
AK16	PB59B	4	BDQ60	C
AC16	PB60A	4	BDQS60	T
GND	GNDIO4	-		
AB16	PB60B	4	BDQ60	C
AH17	PB61A	4	BDQ60	T
AG17	PB61B	4	BDQ60	C
AF17	PB62A	4	BDQ60	T
VCCIO	VCCIO4	4		
AD17	PB62B	4	BDQ60	C
AE17	PB63A	4	BDQ60	T
AC17	PB63B	4	BDQ60	C
AJ17	PB64A	4	BDQ60	T
GND	GNDIO4	-		
AK17	PB64B	4	BDQ60	C
AK18	PB65A	4	BDQ69	T
AJ18	PB65B	4	BDQ69	C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K28	PR25A	2	RDQ29	T (LVDS)*
J24	PR24B	2	RDQ21	C
J26	PR24A	2	RDQ21	T
GND	GNDIO2	-		
K29	PR23B	2	RDQ21	C (LVDS)*
K30	PR23A	2	RDQ21	T (LVDS)*
J23	PR22B	2	RDQ21	C
J25	PR22A	2	RDQ21	T
VCCIO	VCCIO2	99		
J27	PR21B	2	RDQ21	C (LVDS)*
J28	PR21A	2	RDQS21	T (LVDS)*
H26	PR20B	2	RDQ21	C
GND	GNDIO2	-		
H24	PR20A	2	RDQ21	T
J29	PR19B	2	RDQ21	C (LVDS)*
J30	PR19A	2	RDQ21	T (LVDS)*
H25	PR18B	2	RDQ21	C
VCCIO	VCCIO2	2		
H23	PR18A	2	RDQ21	T
G27	PR15B	2	RUM1_SPLLC_FB_A/RDQ12	C
GND	GNDIO2	-		
H27	PR15A	2	RUM1_SPLLT_FB_A/RDQ12	T
G29	PR14B	2	RUM1_SPLLC_IN_A/RDQ12	C (LVDS)*
G28	PR14A	2	RUM1_SPLLT_IN_A/RDQ12	T (LVDS)*
VCCIO	VCCIO2	2		
GND	GNDIO2	-		
G26	PR6B	2		C (LVDS)*
G25	PR6A	2		T (LVDS)*
G30	PR5B	2		C
F30	PR5A	2		T
VCCIO	VCCIO2	2		
F26	PR4B	2		C (LVDS)*
F27	PR4A	2		T (LVDS)*
F29	PR3B	2		C
GND	GNDIO2	-		
F28	PR3A	2		T
H29	PR2B	2	VREF2_2	C (LVDS)*
H30	PR2A	2	VREF1_2	T (LVDS)*
VCCIO	VCCIO2	2		
B26	PT100B	1	VREF2_1	C
A26	PT100A	1	VREF1_1	T
GND	GNDIO1	-		
C25	PT99B	1		C

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
G5	VCCIO7	7		
J8	VCCIO7	7		
K4	VCCIO7	7		
AA22	VCCIO8	8		
U19	VCCIO8	8		
H11	VCCAUX	-		
H12	VCCAUX	-		
L15	VCCAUX	-		
L8	VCCAUX	-		
M15	VCCAUX	-		
M8	VCCAUX	-		
R11	VCCAUX	-		
R12	VCCAUX	-		
A1	GND	-		
A10	GND	-		
A16	GND	-		
A22	GND	-		
AA19	GND	-		
AA4	GND	-		
AB1	GND	-		
AB22	GND	-		
B13	GND	-		
B19	GND	-		
B4	GND	-		
D16	GND	-		
D2	GND	-		
D21	GND	-		
D7	GND	-		
G19	GND	-		
G4	GND	-		
H10	GND	-		
H13	GND	-		
J14	GND	-		
J9	GND	-		
K10	GND	-		
K11	GND	-		
K12	GND	-		
K13	GND	-		
K15	GND	-		
K20	GND	-		
K3	GND	-		
K8	GND	-		
L10	GND	-		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C2	PL2A	7	LDQ6	T (LVDS)*	PL2A	7	LDQ6	T*	
C1	PL2B	7	LDQ6	C (LVDS)*	PL2B	7	LDQ6	C*	
F6	PL3A	7	LDQ6	T	PL3A	7	LDQ6	T	
H9	PL3B	7	LDQ6	C	PL3B	7	LDQ6	C	
D3	PL4A	7	LDQ6	T (LVDS)*	PL4A	7	LDQ6	T*	
VCCIO	VCCIO7	7			VCCIO7	7			
D2	PL4B	7	LDQ6	C (LVDS)*	PL4B	7	LDQ6	C*	
F5	PL5A	7	LDQ6	T	PL5A	7	LDQ6	T	
H8	PL5B	7	LDQ6	C	PL5B	7	LDQ6	C	
E3	PL6A	7	LDQS6	T (LVDS)*	PL6A	7	LDQS6	T*	
GNDIO	GNDIO7	-			GNDIO7	-			
E2	PL6B	7	LDQ6	C (LVDS)*	PL6B	7	LDQ6	C*	
J9	PL7A	7	LDQ6	T	PL7A	7	LDQ6	T	
E4	PL7B	7	LDQ6	C	PL7B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
E1	PL8A	7	LDQ6	T (LVDS)*	PL8A	7	LDQ6	T*	
D1	PL8B	7	LDQ6	C (LVDS)*	PL8B	7	LDQ6	C*	
J8	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7/LDQ6	T	
F4	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7/LDQ6	C	
GNDIO	GNDIO7	-			GNDIO7	-			
-	-	-			VCCIO7	7			
F3	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A	T*	
F1	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A	C*	
G6	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	PL12A	7	LUM0_SPLLT_FB_A	T	
K9	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	PL12B	7	LUM0_SPLLC_FB_A	C	
-	-	-			GNDIO7	-			
G5	PL13A	7	LDQ15	T (LVDS)*	PL13A	7		T*	
VCCIO	VCCIO7	7			-	-			
G4	PL13B	7	LDQ15	C (LVDS)*	PL13B	7		C*	
H5	PL14A	7	LDQ15	T	PL14A	7		T	
-	-	-			VCCIO7	7			
H6	PL14B	7	LDQ15	C	PL14B	7		C	
GNDIO	GNDIO7	-			GNDIO7	-			
J7	PL16A	7	LDQ15	T	PL19A	7		T	
H4	PL16B	7	LDQ15	C	PL19B	7		C	
H3	PL17A	7	LDQ15	T (LVDS)*	PL20A	7		T*	
VCCIO	VCCIO7	7			VCCIO7	7			
G3	PL17B	7	LDQ15	C (LVDS)*	PL20B	7		C*	
GNDIO	GNDIO7	-			GNDIO7	-			
G1	PL19A	7	LDQ23	T (LVDS)*	PL23A	7	LDQ27	T*	
H1	PL19B	7	LDQ23	C (LVDS)*	PL23B	7	LDQ27	C*	
J3	PL20A	7	LDQ23	T	PL24A	7	LDQ27	T	
J4	PL20B	7	LDQ23	C	PL24B	7	LDQ27	C	
VCCIO	VCCIO7	7			VCCIO7	7			
H2	PL21A	7	LDQ23	T (LVDS)*	PL25A	7	LDQ27	T*	
J2	PL21B	7	LDQ23	C (LVDS)*	PL25B	7	LDQ27	C*	
K7	PL22A	7	LDQ23	T	PL26A	7	LDQ27	T	
J6	PL22B	7	LDQ23	C	PL26B	7	LDQ27	C	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
W17	PB65A	4	BDQ69	T	PB56A	4	BDQ60	T	
AA19	PB65B	4	BDQ69	C	PB56B	4	BDQ60	C	
AC15	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T	
Y18	PB68B	4	BDQ69	C	PB57B	4	BDQ60	C	
AB15	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T	
AC16	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AA17	PB60A	4	BDQS60****	T	PB59A	4	BDQ60	T	
AB16	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA15	PB51A	4	BDQS51****	T	PB60A	4	BDQS60	T	
W16	PB59B	4	BDQ60	C	PB60B	4	BDQ60	C	
Y15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AC17	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA18	PB61A	4	BDQ60	T	PB62A	4	BDQ60	T	
Y17	PB61B	4	BDQ60	C	PB62B	4	BDQ60	C	
-	-	-			VCCIO4	4			
GNDIO	GNDIO4	-			-	-			
W15	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AB17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
VCCIO	VCCIO4	4			VCCIO4	4			
V17	PB73A	4	BDQ69	T	PB72A	4	BDQ69	T	
AA20	PB73B	4	BDQ69	C	PB72B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD13	VCC	-			LRC_SQ_VCCR3	13			
AF14	PB47A	4	BDQ51	T	LRC_SQ_HDINP3	13		T	
AE13	NC	-			LRC_SQ_VCCIB3	13			
AE14	PB41A	4	VREF2_4/BDQ42	T	LRC_SQ_HDINN3	13		C	
AD16	VCC	-			LRC_SQ_VCCTX3	13			
AF17	PB51B	4	BDQ51	C	LRC_SQ_HDOUPT3	13		T	
AF16	NC	-			LRC_SQ_VCCOB3	13			
AE17	PB50A	4	BDQ51	T	LRC_SQ_HDOUPTN3	13		C	
AD17	VCC	-			LRC_SQ_VCCTX2	13			
AE18	PB53B	4	BDQ51	C	LRC_SQ_HDOUPTN2	13		C	
AD18	NC	-			LRC_SQ_VCCOB2	13			
AF18	PB53A	4	BDQ51	T	LRC_SQ_HDOUPT2	13		T	
AD14	VCC	-			LRC_SQ_VCCR2	13			
AE15	PB48B	4	BDQ51	C	LRC_SQ_HDINN2	13		C	
AD15	NC	-			LRC_SQ_VCCIB2	13			
AF15	PB47B	4	BDQ51	C	LRC_SQ_HDINP2	13		T	
AD19	VCC	-			LRC_SQ_VCCP	13			
AC19	PB57B	4	BDQ60	C	LRC_SQ_REFCLKP	13		T	
AB19	PB59A	4	BDQ60	T	LRC_SQ_REFCLKN	13		C	
AE19	VCCAUX	-			LRC_SQ_VCCAUX33	13			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K19	VCCIO1	1		
F28	VCCIO2	2		
J25	VCCIO2	2		
K28	VCCIO2	2		
M21	VCCIO2	2		
M24	VCCIO2	2		
N21	VCCIO2	2		
N28	VCCIO2	2		
P21	VCCIO2	2		
R25	VCCIO2	2		
AA28	VCCIO3	3		
AB25	VCCIO3	3		
AE28	VCCIO3	3		
T25	VCCIO3	3		
U21	VCCIO3	3		
V21	VCCIO3	3		
V28	VCCIO3	3		
W21	VCCIO3	3		
W24	VCCIO3	3		
AA18	VCCIO4	4		
AA19	VCCIO4	4		
AE19	VCCIO4	4		
AF22	VCCIO4	4		
AG17	VCCIO4	4		
AG25	VCCIO4	4		
AA12	VCCIO5	5		
AA13	VCCIO5	5		
AE12	VCCIO5	5		
AF9	VCCIO5	5		
AG14	VCCIO5	5		
AG6	VCCIO5	5		
AA3	VCCIO6	6		
AB6	VCCIO6	6		
AE3	VCCIO6	6		
T6	VCCIO6	6		
U10	VCCIO6	6		
V10	VCCIO6	6		
V3	VCCIO6	6		
W10	VCCIO6	6		
W7	VCCIO6	6		
F3	VCCIO7	7		
J6	VCCIO7	7		
K3	VCCIO7	7		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E23	PT82B	1		C	PT100B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
F23	PT82A	1		T	PT100A	1		T
F24	NC	-			PT99B	1		C
G23	NC	-			PT99A	1		T
D23	PT80B	1		C	PT98B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
D22	PT80A	1		T	PT98A	1		T
-	-	-			GNDIO1	-		
-	-	-			VCCIO1	1		
C21	PT79B	1		C	PT88B	1		C
D21	PT79A	1		T	PT88A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
B21	PT77B	1		C	PT86B	1		C
A21	PT77A	1		T	PT86A	1		T
F22	PT76B	1		C	PT85B	1		C
E22	PT76A	1		T	PT85A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
GNDIO	GNDIO1	-			-	-		
J22	NC	-			PT84B	1		C
G22	NC	-			PT84A	1		T
-	-	-			GNDIO1	-		
H22	PT72B	1		C	PT81B	1		C
K22	PT72A	1		T	PT81A	1		T
G21	PT71B	1		C	PT80B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
J21	PT71A	1		T	PT80A	1		T
H21	NC	-			PT79B	1		C
K21	NC	-			PT79A	1		T
D20	PT69B	1		C	PT78B	1		C
F20	PT69A	1		T	PT78A	1		T
C20	PT68B	1		C	PT77B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
E20	PT68A	1		T	PT77A	1		T
G20	PT67B	1		C	PT76B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
J20	PT67A	1		T	PT76A	1		T
A20	PT66B	1		C	PT75B	1		C
B20	PT66A	1		T	PT75A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A19	PT63B	1		C	PT72B	1		C
B19	PT63A	1		T	PT72A	1		T
K20	PT62B	1		C	PT71B	1		C
H20	PT62A	1		T	PT71A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
L19	NC	-			PT70B	1		C
L20	NC	-			PT70A	1		T
E19	PT60B	1		C	PT69B	1		C
C18	PT60A	1		T	PT69A	1		T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO0	-			GNDIO0	-		
G15	PT41A	0		T	PT46A	0		T
J14	NC	-			PT45B	0		C
L15	NC	-			PT45A	0		T
H14	NC	-			PT44B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
K14	NC	-			PT44A	0		T
F15	PT38B	0		C	PT42B	0		C
G14	PT38A	0		T	PT42A	0		T
C15	PT37B	0		C	PT41B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
D14	PT37A	0		T	PT41A	0		T
G13	PT36B	0		C	PT40B	0		C
-	-	-			VCCIO0	0		
J13	PT36A	0		T	PT40A	0		T
B14	PT35B	0		C	PT39B	0		C
VCCIO	VCCIO0	0			-	-		
A14	PT35A	0		T	PT39A	0		T
F13	PT34B	0		C	PT38B	0		C
H13	PT34A	0		T	PT38A	0		T
D13	PT33B	0		C	PT37B	0		C
C14	PT33A	0		T	PT37A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
E13	PT32B	0		C	PT32B	0		C
D12	PT32A	0		T	PT32A	0		T
G12	PT31B	0		C	PT31B	0		C
E12	PT31A	0		T	PT31A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F12	NC	-			PT30B	0		C
D11	NC	-			PT30A	0		T
F11	NC	-			PT29B	0		C
E11	NC	-			PT29A	0		T
D7	ULC_SQ_VCCRX0	11			ULC_SQ_VCCRX0	11		
C9	ULC_SQ_HDINP0	11		T	ULC_SQ_HDINP0	11		T
B9	ULC_SQ_VCCIB0	11			ULC_SQ_VCCIB0	11		
C8	ULC_SQ_HDINN0	11		C	ULC_SQ_HDINN0	11		C
B8	ULC_SQ_VCCTX0	11			ULC_SQ_VCCTX0	11		
A9	ULC_SQ_HDOUTP0	11		T	ULC_SQ_HDOUTP0	11		T
D9	ULC_SQ_VCCOB0	11			ULC_SQ_VCCOB0	11		
A8	ULC_SQ_HDOUTN0	11		C	ULC_SQ_HDOUTN0	11		C
B7	ULC_SQ_VCCTX1	11			ULC_SQ_VCCTX1	11		
A7	ULC_SQ_HDOUTN1	11		C	ULC_SQ_HDOUTN1	11		C
E7	ULC_SQ_VCCOB1	11			ULC_SQ_VCCOB1	11		
A6	ULC_SQ_HDOUTP1	11		T	ULC_SQ_HDOUTP1	11		T
B6	ULC_SQ_VCCRX1	11			ULC_SQ_VCCRX1	11		
C7	ULC_SQ_HDINN1	11		C	ULC_SQ_HDINN1	11		C
D8	ULC_SQ_VCCIB1	11			ULC_SQ_VCCIB1	11		
C6	ULC_SQ_HDINP1	11		T	ULC_SQ_HDINP1	11		T
E6	ULC_SQ_VCCAUX33	11			ULC_SQ_VCCAUX33	11		

LatticeECP2M Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5F484C	304	1.2V	-5	fpBGA	484	COM	20
LFE2M20E-6F484C	304	1.2V	-6	fpBGA	484	COM	20
LFE2M20E-7F484C	304	1.2V	-7	fpBGA	484	COM	20
LFE2M20E-5F256C	140	1.2V	-5	fpBGA	256	COM	20
LFE2M20E-6F256C	140	1.2V	-6	fpBGA	256	COM	20
LFE2M20E-7F256C	140	1.2V	-7	fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5F672C	410	1.2V	-5	fpBGA	672	COM	35
LFE2M35E-6F672C	410	1.2V	-6	fpBGA	672	COM	35
LFE2M35E-7F672C	410	1.2V	-7	fpBGA	672	COM	35
LFE2M35E-5F484C	303	1.2V	-5	fpBGA	484	COM	35
LFE2M35E-6F484C	303	1.2V	-6	fpBGA	484	COM	35
LFE2M35E-7F484C	303	1.2V	-7	fpBGA	484	COM	35
LFE2M35E-5F256C	140	1.2V	-5	fpBGA	256	COM	35
LFE2M35E-6F256C	140	1.2V	-6	fpBGA	256	COM	35
LFE2M35E-7F256C	140	1.2V	-7	fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5F900C	410	1.2V	-5	fpBGA	900	COM	50
LFE2M50E-6F900C	410	1.2V	-6	fpBGA	900	COM	50
LFE2M50E-7F900C	410	1.2V	-7	fpBGA	900	COM	50
LFE2M50E-5F672C	372	1.2V	-5	fpBGA	672	COM	50
LFE2M50E-6F672C	372	1.2V	-6	fpBGA	672	COM	50
LFE2M50E-7F672C	372	1.2V	-7	fpBGA	672	COM	50
LFE2M50E-5F484C	270	1.2V	-5	fpBGA	484	COM	50
LFE2M50E-6F484C	270	1.2V	-6	fpBGA	484	COM	50
LFE2M50E-7F484C	270	1.2V	-7	fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5F1152C	436	1.2V	-5	fpBGA	1152	COM	70
LFE2M70E-6F1152C	436	1.2V	-6	fpBGA	1152	COM	70
LFE2M70E-7F1152C	436	1.2V	-7	fpBGA	1152	COM	70
LFE2M70E-5F900C	416	1.2V	-5	fpBGA	900	COM	70
LFE2M70E-6F900C	416	1.2V	-6	fpBGA	900	COM	70
LFE2M70E-7F900C	416	1.2V	-7	fpBGA	900	COM	70